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#### **FEATURES**

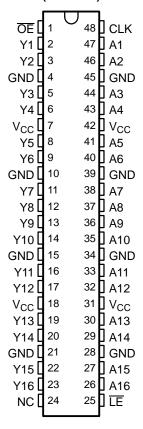
- Member of the Texas Instruments Widebus™ Family
- Ideal for Use in PC100 Register DIMM
- Operates From 1.65 V to 3.6 V
- Max t<sub>nd</sub> of 3.8 ns at 3.3 V
- ±12-mA Output Drive at 3.3 V
- Output Ports Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- Designed to Comply With JEDEC 168-Pin and 200-Pin SDRAM Buffered DIMM Specification
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### **DESCRIPTION/ORDERING INFORMATION**

This 16-bit universal bus driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

Data flow from A to Y is controlled by the output-enable  $(\overline{OE})$  input. The device operates in the transparent mode when the latch-enable  $(\overline{LE})$  input is low. When  $\overline{LE}$  is high, the A data is latched if the clock (CLK) input is held at a high or low logic level. If  $\overline{LE}$  is high, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

# DGG, DGV, OR DL PACKAGE (TOP VIEW)



NC - No internal connection

The outputs, which are designed to sink up to 12 mA, include equivalent 26- $\Omega$  resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### ORDERING INFORMATION

| T <sub>A</sub> | PAC         | KAGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |
|----------------|-------------|---------------------|-----------------------|------------------|--|
|                | SSOP - DL   | Tube                | SN74ALVC162334DL      | ALVC162334       |  |
| 40°C to 95°C   | 330P - DL   | Tape and reel       | SN74ALVC162334DLR     |                  |  |
| -40°C to 85°C  | TSSOP - DGG | Tape and reel       | SN74ALVC162334DGGR    | ALVC162334       |  |
|                | TVSOP - DGV | Tape and reel       | SN74ALVC162334DGVR    | VC2334           |  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

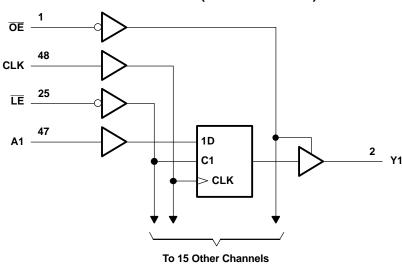


### **FUNCTION TABLE**

|    | INP | PUTS   |   | OUTPUT                        |
|----|-----|--------|---|-------------------------------|
| ŌĒ | LE  | CLK    | Α | Y                             |
| Н  | Χ   | X      | Χ | Z                             |
| L  | L   | X      | L | L                             |
| L  | L   | X      | Н | Н                             |
| L  | Н   | 1      | L | L                             |
| L  | Н   | 1      | Н | Н                             |
| L  | Н   | L or H | Χ | Y <sub>0</sub> <sup>(1)</sup> |

(1) Output level before the indicated steady-state input conditions were established

### **LOGIC DIAGRAM (POSITIVE LOGIC)**





### SN74ALVC162334 16-BIT UNIVERSAL BUS DRIVER WITH 3-STATE OUTPUTS

## **ABSOLUTE MAXIMUM RATINGS**(1)

over operating free-air temperature range (unless otherwise noted)

|                  |   |                    | MIN  | MAX            | UNIT |
|------------------|---|--------------------|------|----------------|------|
| $V_{CC}$         | Supply voltage range                                  |                    | -0.5 | 4.6            | V    |
| VI               | Input voltage range <sup>(2)</sup>                    |                    | -0.5 | 4.6            | V    |
| $V_{O}$          | Output voltage range <sup>(2)(3)</sup>                |                    | -0.5 | $V_{CC} + 0.5$ | V    |
| I <sub>IK</sub>  | Input clamp current                                   | V <sub>1</sub> < 0 |      | -50            | mA   |
| I <sub>OK</sub>  | Output clamp current                                  |                    | -50  | mA             |      |
| Io               | Continuous output current                             |                    | ±50  | mA             |      |
|                  | Continuous current through each V <sub>CC</sub> or GN | ID                 |      | ±100           | mA   |
|                  |   | DGG package        |      | 70             |      |
| $\theta_{JA}$    | Package thermal impedance (4)                         | DGV package        |      | 58             | °C/W |
|                  |   | DL package         |      | 63             |      |
| T <sub>stg</sub> | Storage temperature range                             |                    | -65  | 150            | °C   |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### **RECOMMENDED OPERATING CONDITIONS**(1)

|                     |                                    |  | MIN                  | MAX                  | UNIT |  |
|---------------------|------------------------------------|--|----------------------|----------------------|------|--|
| V <sub>CC</sub>     | Supply voltage                     |  | 1.65                 | 3.6                  | V    |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V         | $0.65 \times V_{CC}$ |                      |      |  |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7                  |                      | V    |  |
|                     |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V           | 2                    |                      |      |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V         |                      | $0.35 \times V_{CC}$ |      |  |
| $V_{IL}$            | Low-level input voltage            | V <sub>CC</sub> = 2.3 V to 2.7 V           |                      | 0.7                  | V    |  |
|                     |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V           |                      | 0.8                  |      |  |
| VI                  | Input voltage                      |  | 0                    | 3.6                  | V    |  |
| Vo                  | Output voltage                     | 0  | V <sub>CC</sub>      | V                    |      |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V                   |                      | -2                   |      |  |
|                     | IPak basel extent comment          | V <sub>CC</sub> = 2.3 V                    |                      | -6                   | mA   |  |
| I <sub>OH</sub>     | High-level output current          | V <sub>CC</sub> = 2.7 V                    |                      | -8                   |      |  |
|                     |                                    | V <sub>CC</sub> = 3 V                      |                      | -12                  |      |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V                   |                      | 2                    |      |  |
|                     | Low lovel output ourrest           | V <sub>CC</sub> = 2.3 V                    |                      | 6                    | A    |  |
| l <sub>OL</sub>     | Low-level output current           | V <sub>CC</sub> = 2.7 V                    |                      | 8                    | mA   |  |
|                     |                                    | V <sub>CC</sub> = 3 V                      |                      | 12                   |      |  |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |  | 10                   | ns/V                 |      |  |
| T <sub>A</sub>      | Operating free-air temperature     |  | -40                  | 85                   | °C   |  |

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

<sup>(2)</sup> The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>3)</sup> This value is limited to 4.6 V maximum.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

SCES127E-FEBRUARY 1998-REVISED OCTOBER 2004



### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| Р               | ARAMETER       | TEST CONDITIONS  | V <sub>cc</sub> | MIN TYP(1) MAX        | UNIT |  |  |
|-----------------|----------------|--|-----------------|-----------------------|------|--|--|
|                 |                | I <sub>OH</sub> = -100 μA                                      | 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2 |      |  |  |
|                 |                | $I_{OH} = -2 \text{ mA}$                                       | 1.65 V          | 1.2                   |      |  |  |
|                 |                | $I_{OH} = -4 \text{ mA}$                                       | 2.3 V           | 1.9                   |      |  |  |
| $V_{OH}$        |                | L 6 mA   | 2.3 V           | 1.7                   | V    |  |  |
|                 |                | I <sub>OH</sub> = -6 mA  | 3 V             | 2.4                   |      |  |  |
|                 |                | $I_{OH} = -8 \text{ mA}$                                       | 2.7 V           | 2                     |      |  |  |
|                 |                | I <sub>OH</sub> = -12 mA                                       | 3 V             | 2                     |      |  |  |
|                 |                | I <sub>OL</sub> = 100 μA                                       | 1.65 V to 3.6 V | 0.2                   |      |  |  |
|                 |                | I <sub>OL</sub> = 2 mA   | 1.65 V          | 0.45                  |      |  |  |
|                 | $V_OL$         | I <sub>OL</sub> = 4 mA   | 2.3 V           | 0.4                   |      |  |  |
| $V_{OL}$        |                | L 6 mA   | 2.3 V           | 0.55                  | V    |  |  |
|                 |                | I <sub>OL</sub> = 6 mA   | 3 V             | 0.55                  |      |  |  |
|                 |                | I <sub>OL</sub> = 8 mA   | 2.7 V           | 0.6                   |      |  |  |
|                 |                | I <sub>OL</sub> = 12 mA  | 3 V             | 0.8                   |      |  |  |
| I               |                | V <sub>I</sub> = V <sub>CC</sub> or GND                        | 3.6 V           | ±5                    | μΑ   |  |  |
| loz             |                | $V_O = V_{CC}$ or GND  | 3.6 V           | ±10                   | μΑ   |  |  |
| I <sub>CC</sub> |                | $V_I = V_{CC}$ or GND, $I_O = 0$                               | 3.6 V           | 40                    | μΑ   |  |  |
| $\Delta I_{CC}$ |                | One input at $V_{CC}$ - 0.6 V, Other inputs at $V_{CC}$ or GND | 3 V to 3.6 V    | 750                   | μΑ   |  |  |
| <u> </u>        | Control inputs | V V or CND   | 221/            | 5                     | ~F   |  |  |
| Ci              | Data inputs    | $V_{I} = V_{CC}$ or GND  | 3.3 V           | 5.5                   | pF   |  |  |
| Co              | Outputs        | $V_O = V_{CC}$ or GND  | 3.3 V           | 7.5                   | pF   |  |  |

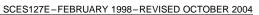
<sup>(1)</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C.

### **TIMING REQUIREMENTS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                    |                 |                             |                 | V <sub>CC</sub> = 1.8 V |     | $V_{CC} = 1.8 \text{ V}$ $V_{CC} = 2.5 \text{ V} \\ \pm 0.2 \text{ V}$ $V_{CC} = 1.8 \text{ V}$ |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|--------------------|-----------------|-----------------------------|-----------------|-------------------------|-----|---|-----|-------------------------|-----|------------------------------------|-----|------|
|                    |                 |                             |                 | MIN                     | MAX | MIN   | MAX | MIN                     | MAX | MIN                                | MAX |      |
| f <sub>clock</sub> | Clock frequency |                             |                 |                         | (1) |   | 150 |                         | 150 |                                    | 150 | MHz  |
| t Pulse duration   | LE low          | E low                       |                 |                         | 3.3 |   | 3.3 |                         | 3.3 |                                    | 20  |      |
| t <sub>w</sub>     | CLK high or low |                             |                 | (1)                     |     | 3.3   |     | 3.3                     |     | 3.3                                |     | ns   |
|                    |                 | Data before CLK↑            |                 | (1)                     |     | 1.4   |     | 1.7                     |     | 1.5                                |     |      |
| t <sub>su</sub>    | Setup time      | Data before <del>LE</del> ↑ | CLK high        | (1)                     |     | 1.2   |     | 1.6                     |     | 1.3                                |     | ns   |
|                    |                 | Data before LET             | CLK low         | (1)                     |     | 1.4   |     | 1.5                     |     | 1.2                                |     |      |
|                    | t Hald Care     | Data after CLK↑             | Data after CLK↑ |                         |     | 0.9   |     | 0.9                     |     | 0.9                                |     |      |
| t <sub>h</sub>     | поій шпе        | old time Data after LE↑     |                 | (1)                     |     | 1.1   |     | 1.1                     |     | 1.1                                |     | ns   |

<sup>(1)</sup> This information was not available at the time of publication.





### **SWITCHING CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = 1.8 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 2.7 V |     | $V_{CC}$ = 3.3 V $\pm$ 0.3 V |     | UNIT |
|------------------|-----------------|----------------|-------------------------|-----|------------------------------------|-----|-------------------------|-----|------------------------------|-----|------|
|                  | (INPOT)         | (OUTPUT)       | MIN                     | TYP | MIN                                | MAX | MIN                     | MAX | MIN                          | MAX |      |
| f <sub>max</sub> |                 |                | (1)                     |     | 150                                |     | 150                     |     | 150                          |     | MHz  |
|                  | Α               |                |                         | (1) | 1                                  | 4.4 |                         | 4.5 | 1.1                          | 3.9 |      |
| t <sub>pd</sub>  | ĪĒ              | Υ              |                         | (1) | 1                                  | 5.8 |                         | 6   | 1.3                          | 5   | ns   |
|                  | CLK             |                |                         | (1) | 1                                  | 5.2 |                         | 5.4 | 1                            | 4.9 |      |
| t <sub>en</sub>  | ŌĒ              | Y              |                         | (1) | 1                                  | 6.4 |                         | 6.4 | 1.1                          | 5.4 | ns   |
| t <sub>dis</sub> | ŌĒ              | Y              |                         | (1) | 1                                  | 4.7 |                         | 5.1 | 1.7                          | 5   | ns   |

<sup>(1)</sup> This information was not available at the time of publication.

#### **SWITCHING CHARACTERISTICS**

from  $0^{\circ}$ C to  $65^{\circ}$ C,  $C_{L} = 50 \text{ pF}$ 

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = ± 0.1 | UNIT |    |
|-----------------|-----------------|----------------|-------------------------|------|----|
|                 | ( 51)           | (6611 61)      | MIN                     | MAX  |    |
|                 | Α               | Y              | 1.2                     | 3.8  | 20 |
| <sup>L</sup> pd | CLK             | Y              | 1.1                     | 4.8  | ns |

### **OPERATING CHARACTERISTICS**

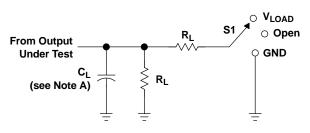
 $T_A = 25^{\circ}C$ 

|     | PARAMETE                    | TEST CONDITIONS  | V <sub>CC</sub> = 1.8 V          | V <sub>CC</sub> = 2.5 V<br>TYP | V <sub>CC</sub> = 3.3 V<br>TYP | UNIT |     |
|-----|-----------------------------|------------------|----------------------------------|--------------------------------|--------------------------------|------|-----|
|     | Power dissipation           | Outputs enabled  | $C_1 = 0$ . $f = 10 \text{ MHz}$ | (1)                            | 31                             | 36   | , r |
| Cpd | C <sub>pd</sub> capacitance | Outputs disabled | $C_L = 0$ , $f = 10 \text{ MHz}$ | (1)                            | 7                              | 11   | p⊦  |

<sup>(1)</sup> This information was not available at the time of publication.



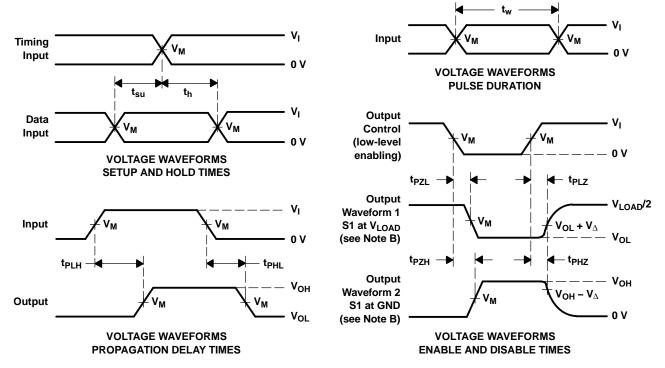
#### PARAMETER MEASUREMENT INFORMATION



| TEST                               | S1                |
|------------------------------------|-------------------|
| t <sub>pd</sub>                    | Open              |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>LOAD</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

LOAD CIRCUIT

| V                 | INPUT           |                                | V                  | v                 |       | ь              | V                     |  |
|-------------------|-----------------|--------------------------------|--------------------|-------------------|-------|----------------|-----------------------|--|
| V <sub>CC</sub>   | VI              | t <sub>r</sub> /t <sub>f</sub> | V <sub>M</sub>     | V <sub>LOAD</sub> | CL    | R <sub>L</sub> | $\mathbf{V}_{\Delta}$ |  |
| 1.8 V             | V <sub>CC</sub> | ≤ <b>2</b> ns                  | V <sub>CC</sub> /2 | 2×V <sub>CC</sub> | 30 pF | <b>1 k</b> Ω   | 0.15 V                |  |
| 2.5 V $\pm$ 0.2 V | V <sub>CC</sub> | ≤2 ns                          | V <sub>CC</sub> /2 | 2×V <sub>CC</sub> | 30 pF | 500 Ω          | 0.15 V                |  |
| 2.7 V             | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | 500 Ω          | 0.3 V                 |  |
| 3.3 V $\pm$ 0.3 V | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | 500 Ω          | 0.3 V                 |  |



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{\Omega}$  = 50  $\Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins   | Package qty   Carrier | RoHS | Lead finish/  | MSL rating/        | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
|                       | (1)    | (2)           |                  |                       | (3)  | Ball material | Peak reflow        |              | (6)          |
|                       |        |               |                  |                       |      | (4)           | (5)                |              |              |
| SN74ALVC162334DGGR    | Active | Production    | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ALVC162334   |
| SN74ALVC162334DGGR.B  | Active | Production    | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ALVC162334   |
| SN74ALVC162334DGVR    | Active | Production    | TVSOP (DGV)   48 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | VC2334       |
| SN74ALVC162334DGVR.B  | Active | Production    | TVSOP (DGV)   48 | 2000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | VC2334       |
| SN74ALVC162334DLR     | Active | Production    | SSOP (DL)   48   | 1000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ALVC162334   |
| SN74ALVC162334DLR.B   | Active | Production    | SSOP (DL)   48   | 1000   LARGE T&R      | Yes  | NIPDAU        | Level-1-260C-UNLIM | -40 to 85    | ALVC162334   |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



## **PACKAGE OPTION ADDENDUM**

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## **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





|    | · · · · · · · · · · · · · · · · · · ·                     |
|----|---|
| A0 | Dimension designed to accommodate the component width     |
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

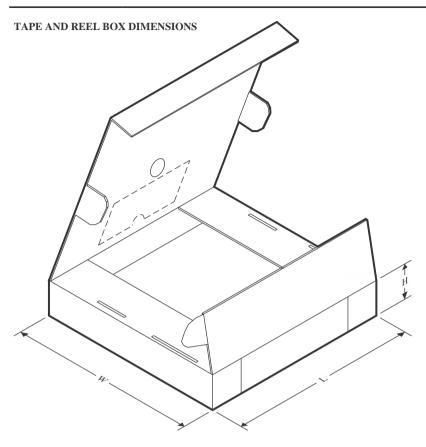


#### \*All dimensions are nominal

| Device             | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ALVC162334DGGR | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74ALVC162334DGVR | TVSOP           | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |
| SN74ALVC162334DLR  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

## **PACKAGE MATERIALS INFORMATION**

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### \*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALVC162334DGGR | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ALVC162334DGVR | TVSOP        | DGV             | 48   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74ALVC162334DLR  | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

### DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



SMALL OUTLINE PACKAGE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

## DL (R-PDSO-G48)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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